

FAST RECOVERY RECTIFIER DIODES

FAST RECOVERY RECTIFIER

- VERY LOW REVERSE RECOVERY TIME
- VERY LOW SWITCHING LOSSES
- LOW NOISE TURN-OFF SWITCHING



F 126
(Plastic)

SUITABLE APPLICATION

- FREE WHEELING DIODE IN CONVERTERS AND MOTORS CIRCUITS
- RECTIFIER IN S.M.P.S.

ABSOLUTE RATINGS (limiting values)

Symbol	Parameter		Value	Unit
I _{FRM}	Repetitive Peak Forward Current	t _p ≤ 10µs	30	A
I _{F (AV)}	Average Forward Current*	T _a = 70°C δ = 0.5	1	A
I _{FSM}	Surge non Repetitive Forward Current	t _p = 10ms Sinusoidal	30	A
P	Power Dissipation*	T _a = 70°C	1.33	W
T _{stg} T _j	Storage and Junction Temperature Range		- 40 to +150 - 40 to + 150	°C

Symbol	Parameter	BYT 01-			Unit
		200	300	400	
V _{RRM}	Repetitive Peak Reverse Voltage	200	300	400	V
V _{RSM}	Non Repetitive Peak Reverse Voltage	220	330	440	V

THERMAL RESISTANCE

Symbol	Parameter		Value	Unit
R _{th (j - a)}	Junction-ambient*		60	°C/W

* On infinite heatsink with 10mm lead length.

ELECTRICAL CHARACTERISTICS**STATIC CHARACTERISTICS**

Symbol	Test Conditions			Min.	Typ.	Max.	Unit
I_R	$T_j = 25^\circ C$	$V_R = V_{RRM}$				20	μA
	$T_j = 100^\circ C$					0.5	mA
V_F	$T_j = 25^\circ C$	$I_F = 1A$				1.5	V
	$T_j = 100^\circ C$					1.4	

RECOVERY CHARACTERISTICS

Symbol	Test Conditions			Min.	Typ.	Max.	Unit
t_{rr}	$T_j = 25^\circ C$	$I_F = 1A$	$dI_F/dt = - 15A/\mu s$	$V_R = 30V$		55	ns
	$T_j = 25^\circ C$	$I_F = 0.5A$	$I_R = 1A$		$I_{rr} = 0.25A$	25	

TURN-OFF SWITCHING CHARACTERISTICS (Without Series inductance)

Symbol	Test Conditions				Min.	Typ.	Max.	Unit
t_{IRM}	$dI_F/dt = - 50A/\mu s$	$T_j = 100^\circ C$	$V_{CC} = 200 V$	$I_F = 1A$		35	50	ns
I_{RM}	$dI_F/dt = - 50A/\mu s$	$L_p \leq 0.05 \mu A$	See figure 12			1.5	2	A

To evaluate the conduction losses use the following equations:

$$V_F = 1.05 + 0.145 I_F \quad P = 1.05 \times I_{F(AV)} + 0.145 I_F^2 (RMS)$$

Figure 1. Maximum average power dissipation versus average forward current.

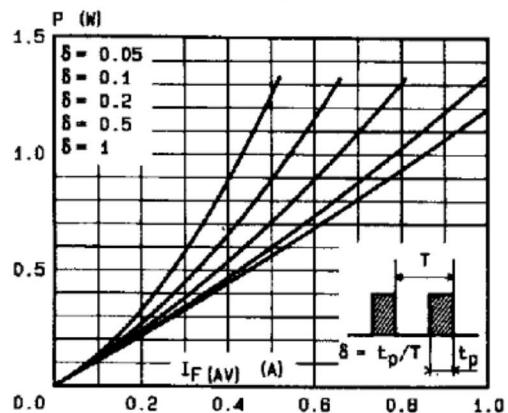


Figure 2. Average forward current versus ambient temperature.

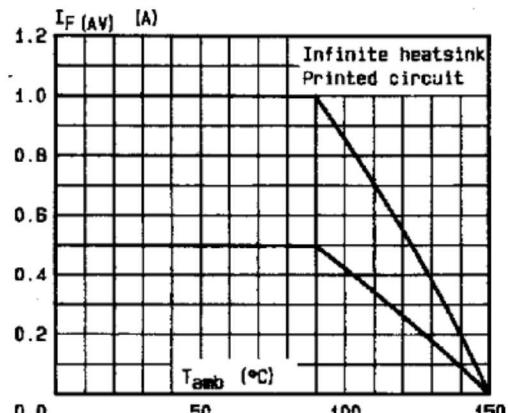


Figure 3. Thermal resistance versus lead length.

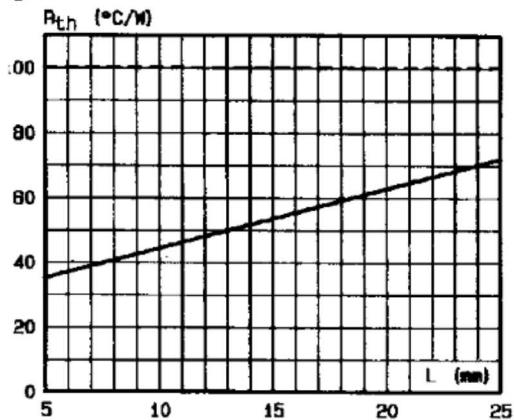
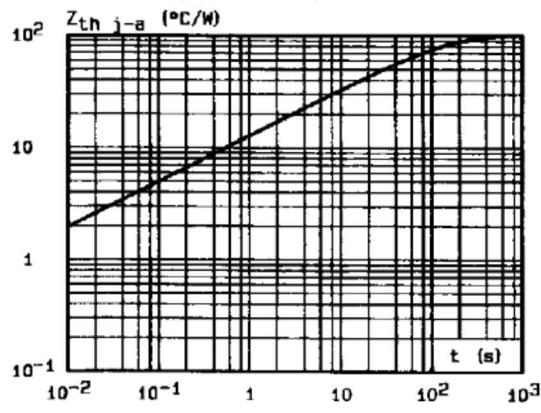
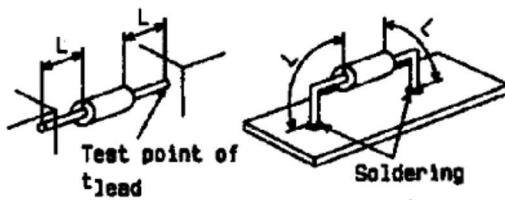


Figure 4. Transient thermal impedance junction-ambient for mounting n°2 versus pulse duration (L = 10 mm).



**Mounting n°1
INFINITE HEATSINK**



**Mounting n°2
PRINTED CIRCUIT**

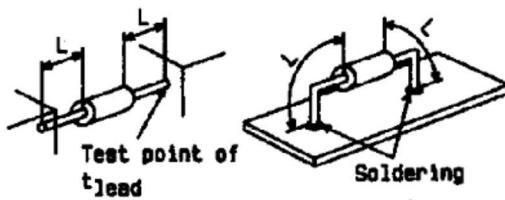


Figure 5. Peak forward current versus peak forward voltage drop (maximum values).

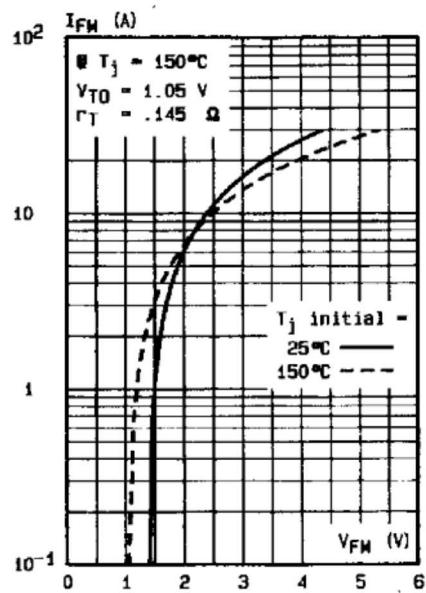


Figure 7. Recovery time versus dI_F/dt .

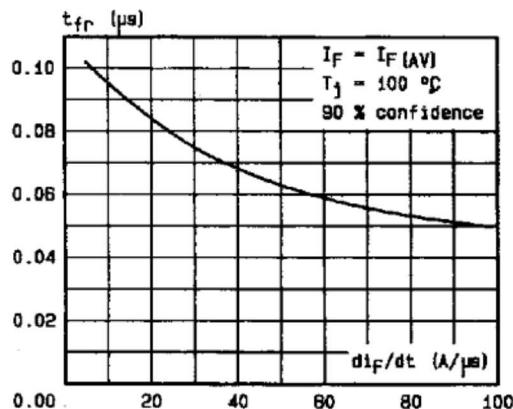


Figure 8. Peak forward voltage versus dI_F/dt .

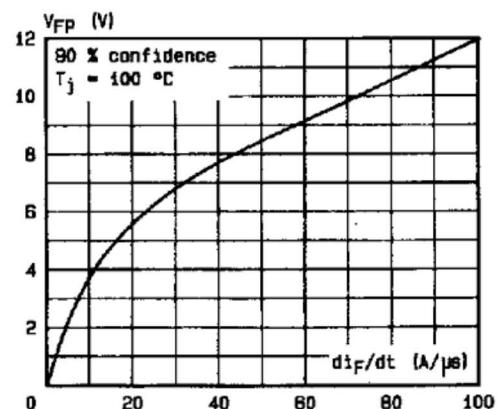


Figure 9. Peak reverse current versus dI_F/dt .

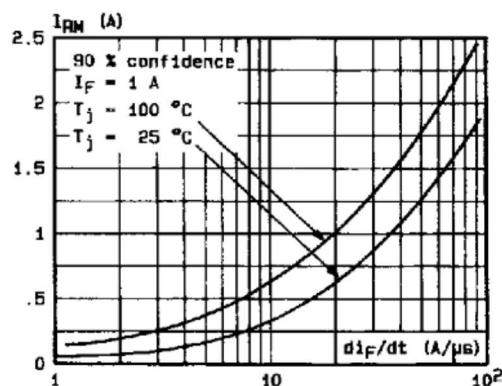


Figure 10. Recovered charge versus dI_F/dt (typical values).

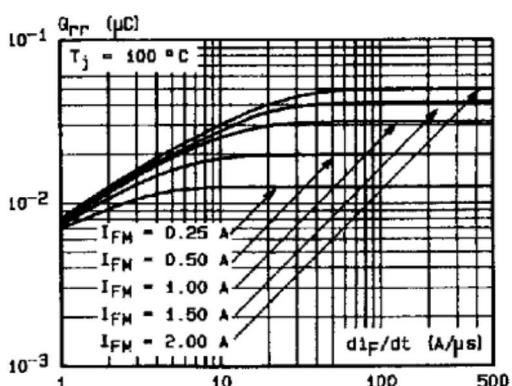


Figure 11. Dynamic parameters versus junction temperature.

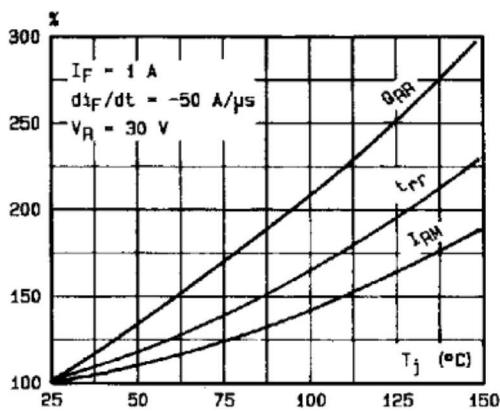
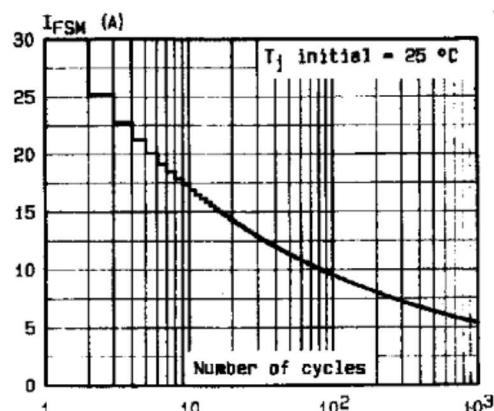
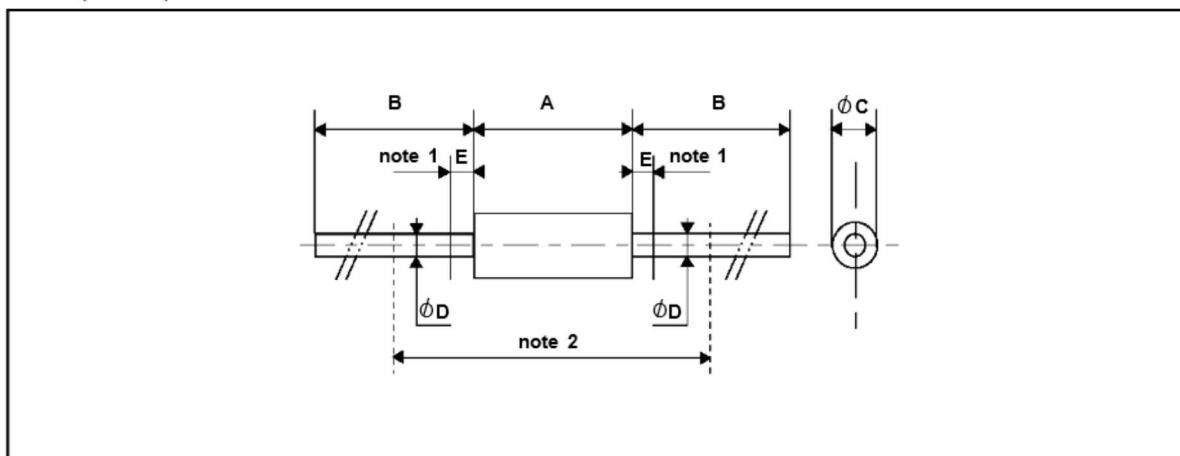


Figure 12. Non repetitive surge peak current versus number of cycles.



PACKAGE MECHANICAL DATA

F 126 (Plastic)



REF.	DIMENSIONS				NOTES	
	Millimeters		Inches			
	Min.	Max.	Min.	Max.		
A	6.05	6.35	0.238	0.250	1 - The lead diameter \emptyset D is not controlled over zone E	
B	26		1.024		2 - The minimum axial length within which the device may be placed with its leads bent at right angles is 0.59"(15 mm)	
\emptyset C	2.95	3.05	0.116	0.120		
\emptyset D	0.76	0.86	0.029	0.034		
E		1.27		0.050		

Cooling method: by convection (method A)

Marking: type number

Weight: 0.4g

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